### **ASSP**

# **VOLTAGE DETECTOR**

## **MB3761**

#### **■** DESCRIPTION

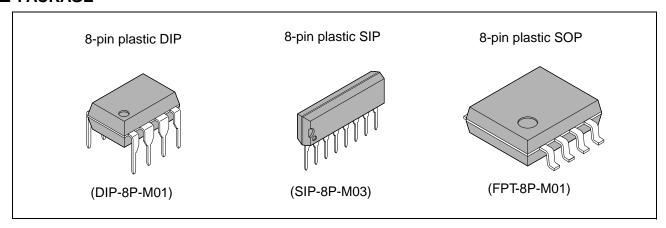
Designed for voltage detector applications, the Fujitsu MB3761 is a dual comparator with a built-in high precision reference voltage generator. Outputs are open-collector outputs and enable use of the OR-connection between both channels. Both channels have hysteresis control outputs. Because of a wide power supply voltage range and a low power supply current, the MB3761 is suitable for power supply monitors and battery backup systems.

#### **■ FEATURES**

- Wide power supply voltage range: 2.5 V to 40 V
- Low power and small voltage dependency supply current: 250 μA Typ
- Built-in stable low voltage generator: 1.20 V Typ
- Easy-to-add hysteresis characteristics.
- Package: 8-pin Plastic SIP Package (Suffix: -PS)

8-pin Plastic DIP Package (Suffix: -P) 8-pin Plastic SOP Package (Suffix: -PF)

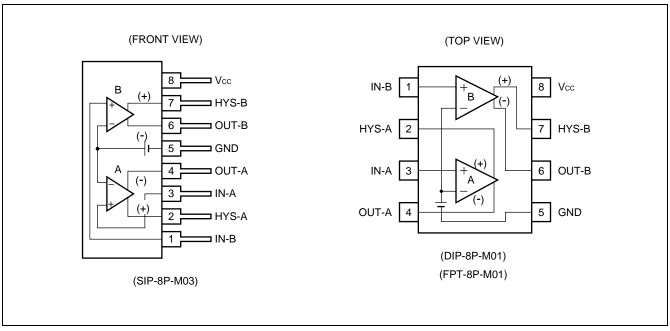
#### **■ PACKAGE**



Note: This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.



### **■ PIN ASSIGNMENT**



#### ■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rat	Unit	
raiametei	Symbol	Min	Min Max	
Power Supply Voltage	Vcc		41	V
Output Voltage	Vo		41	V
Output Current	lo		50	mA
Input Voltage	Vin	- 0.3	+ 6.5	V
Power Dissipation	PD	_	350 (T <sub>A</sub> ≤ +70°C)	mW
Storage Temperature	Tstg	- 55	+ 125	°C

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

#### ■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Val	Unit	
		Min	Max	Oilit
Power Supply Voltage	Vcc	2.5	40	V
Operating Temperature	TA	- 20	+ 75	°C
Output Current at pin 4	<b>I</b> O4	_	4.5	mA
Output Current at pin 6	IO6	_	3.0	mA

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

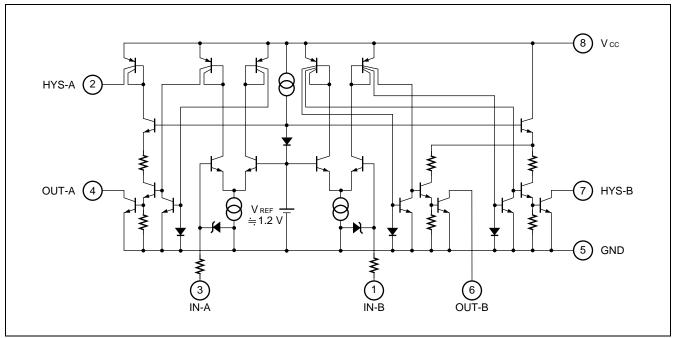
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

### **■ ELECTRICAL CHARACTERISTICS**

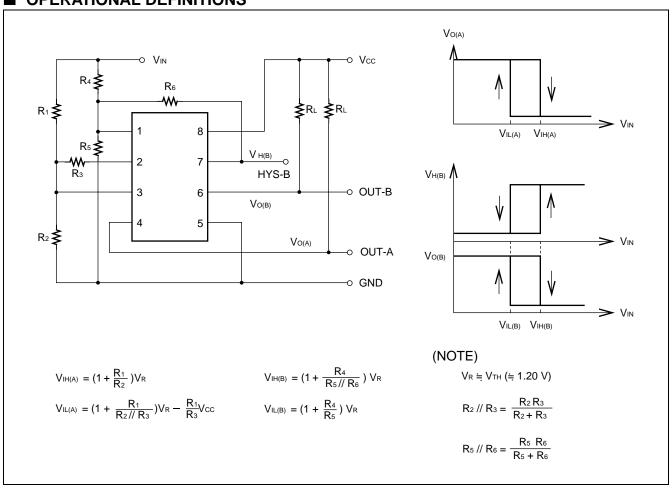
(TA=+25°C, VCC=5 V)

Parameter	Cymhol	ol Conditions	Value			l lmi4
	Symbol Conditions	Min	Тур	Max	Unit	
Power Supply Voltage	ICCL	VCC= 40 V, VIL= 1.0 V	-	250	400	μΑ
	Іссн	VCC= 40 V, VIH= 1.5 V	-	400	600	μΑ
Threshold Voltage	VTH	Io = 2 mA, Vo= 1 V	1.15	1.20	1.25	V
Deviation of Threshold Voltage	$\Delta$ VTH1	2.5 V ≤ Vcc ≤ 5.5 V	-	3	12	mV
	$\Delta$ VTH2	4.5 V ≤ Vcc ≤ 40 V	-	10	40	mV
Offset Voltage between Outputs	Voosa	IOA= 4.5 mA, VOA= 2 V, IHA= 20 μA, VHA= 3 V	-	2.0	-	mV
	Vossb	IOB= 3 mA, VOB= 2 V, IHB= 3 mA, VHB= 2 V	-	2.0	-	mV
Temperature Coefficient of Threshold Voltage	α	-20°C ≤ TA ≤ +70°C	-	±0.05	-	mV/°C
Difference Voltage on Threshold Voltage between Channel	$\Delta$ VTHAB		-10	-	-10	mV
	lıL	VIL= 1.0 V	-	5		nA
Input Current	lін	VIH= 1.5 V	-	100	500	nA
Output Leakage Current	Іон	Vo= 40 V, VIL= 1.0 V	-	-	1	μΑ
Hysteresis Output Leakage Current	İHLA	VCC= 40 V, VHA= 0 V, VIL= 1.0 V	-	-	0.1	μΑ
	Іннв	VHB= 40 V, VIH= 1.5 V	-	-	1	μΑ
Output Sink Current	IOLA	Vo= 1.0 V, VIH= 1.5 V	6	12	-	mA
	lolb	Vo= 1.0 V, VIH= 1.5 V	4	10	-	mA
Hysteresis Current	Інна	VH= 0 V, VIH= 1.5 V	40	80	-	μΑ
	IHLB	VH= 1.0 V,VIL= 1.0 V	4	10	-	mA
Output Saturation Voltage	Vola	IO= 4.5 mA, VIH= 1.5 V	-	120	400	mV
	Volb	IO= 3.0 mA, VIH= 1.5 V	-	120	400	mV
Hysteresis Saturation	VHHA	IH= 20 μA, VIH= 1.5 V	-	50	200	mV
	VHLB	IH= 3.0 mA, VIL= 1.0 V	-	120	400	mV
Output Delay Time	tPHL	RL= 5 kΩ	-	2	-	μs
	tPLH	$RL=5 k\Omega$	-	3	-	μs

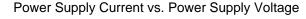
#### **■ EQUIVALENT CIRCUIT**

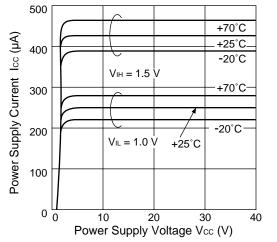


#### **■** OPERATIONAL DEFINITIONS

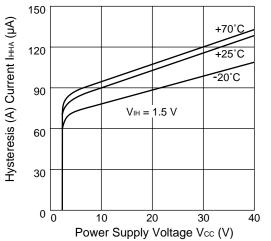


#### **■ TYPICAL PERFORMANCE CHARACTERISTICS**

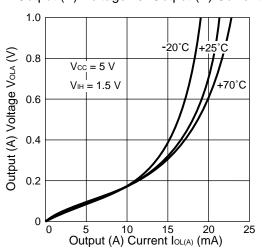




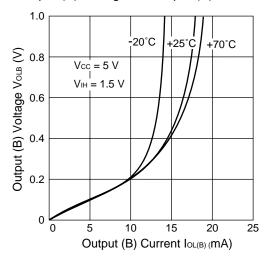
Hysteresis (A) Current vs. Power Supply Voltage



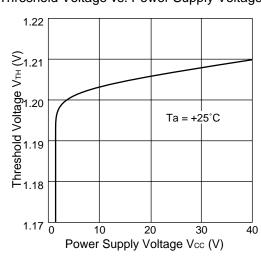
Output (A) Voltage vs. Output (A) Current



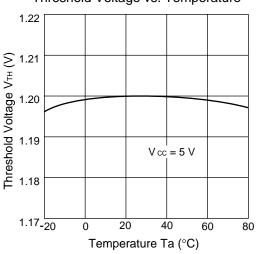
Output (B) Voltage vs. Output (B) Current



Threshold Voltage vs. Power Supply Voltage

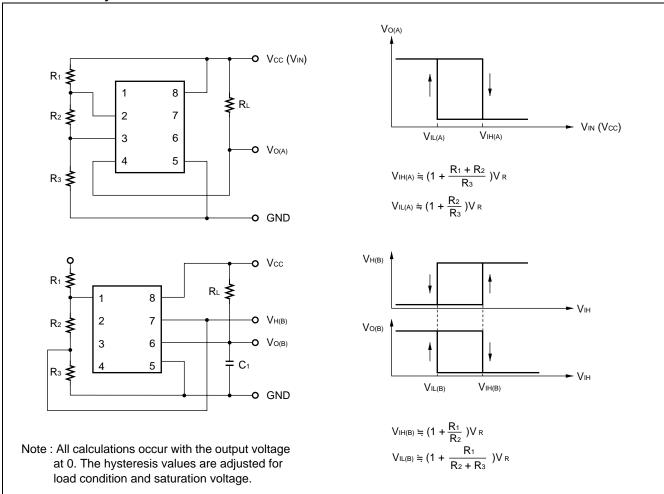


Threshold Voltage vs. Temperature

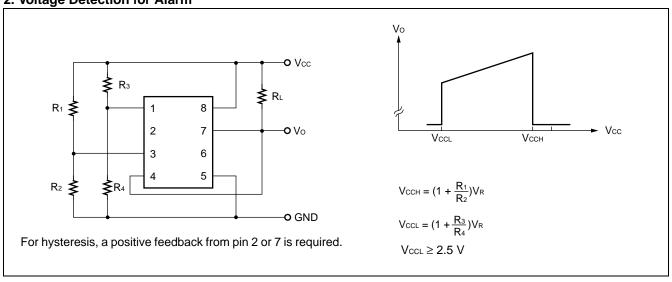


#### **■ APPLICATION EXAMPLES**

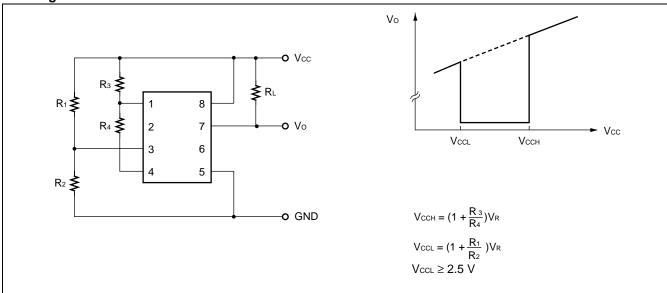
#### 1. Addition of Hysteresis



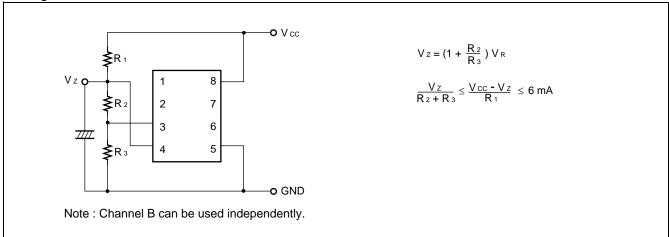
#### 2. Voltage Detection for Alarm



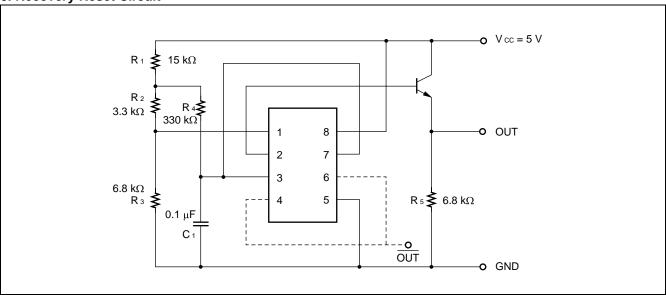
### 3. Voltage Detection for Alarm



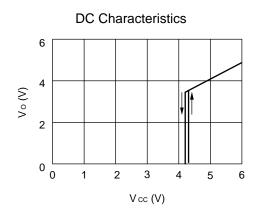
#### 4. Programmable Zener



### 5. Recovery Reset Circuit



#### **■ TYPICAL CHARACTERISTICS**



 Voltage Threshold Levels (VccL and VccH) and Hysteresis Width can be changed by the resistors (R1 through R4).

$$VCCL = \frac{R_1 + R_2 + R_3}{R_3} V_{TH}$$

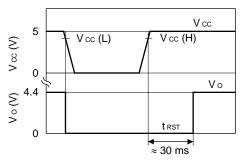
$$VCCH = VCCL + \frac{R_1 (R_2 + R_3)}{R_3 R_4} V_{TH}$$

Power-On Reset Time is provided by the following approximate equation:

trst = -C1 R4 • In 
$$\left\{1 - \frac{V_{TH}}{V_{CC}} \left(1 + \frac{R_1}{R_2 + R_3}\right)\right\}$$

- The recommended value of hFE of the external transistor is from 50 to 200.
- In the case of an instant power fail, the remaining charge in C1 effects trst.
- If necessary, the reversed output is provided on HYS terminal

#### Response Characteristics



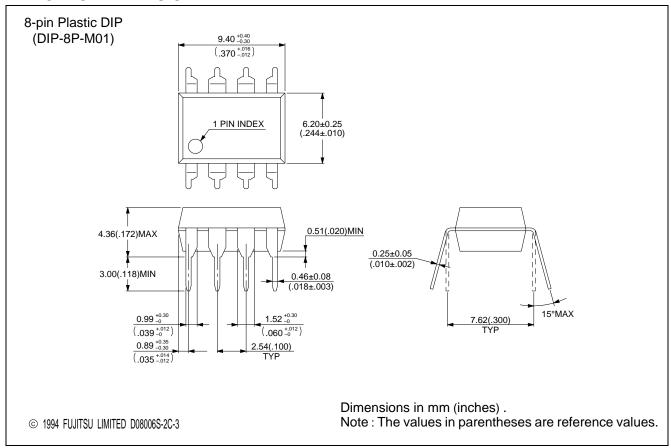
#### **■ NOTES ON USE**

- Take account of common impedance when designing the earth line on a printed wiring board.
- Take measures against static electricity.
  - For semiconductors, use antistatic or conductive containers.
  - When storing or carrying a printed circuit board after chip mounting, put it in a conductive bag or container.
  - The work table, tools and measuring instruments must be grounded.
  - The worker must put on a grounding device containing 250 k $\Omega$  to 1 M $\Omega$  resistors in series.
- Do not apply a negative voltage
  - Applying a negative voltage of -0.3 V or less to an LSI may generate a parasitic transistor, resulting in malfunction.

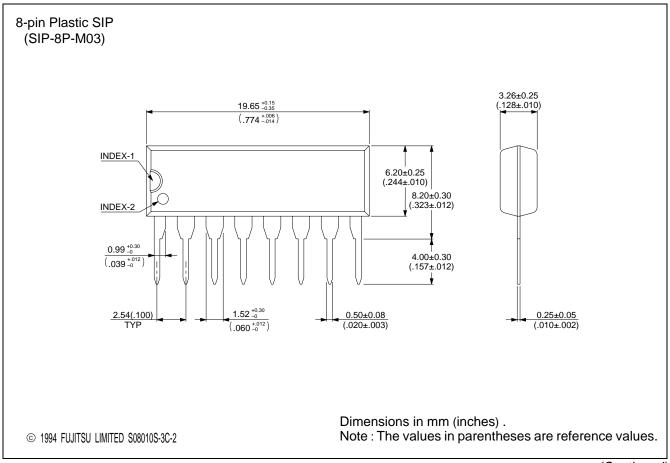
#### **■ ORDERING INFORMATION**

Part number	Package	Remarks
MB3761M	8-pin Plastic DIP (DIP-8P-M01)	
MB3761PS	8-pin Plastic SIP (SIP-8P-M03)	
MB3761PF	8-pin Plastic SOP (FPT-8P-M01)	

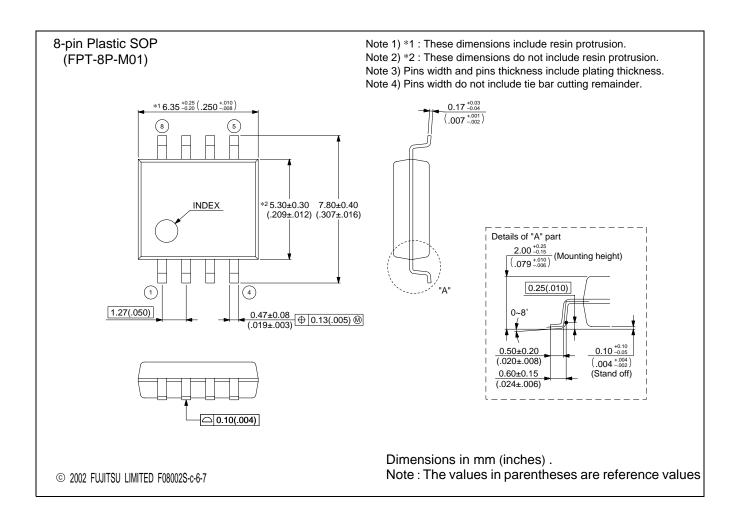
#### **■ PACKAGE DIMENSION**



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